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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

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	ROSE E	Note QT: Qual	WIL-STD-1344.	MARKS MP STRENGTH	LIBABIL	RESISTANCE TO SOLDERING HEAT	SULPHUR DIOXIDE	YDROGEN SULP	CORROSION SALT MIST	DRY HEAT	DAMP HEAT. CYCLIC	D CHANGE OF ERATURE	MP HEAT (STEADY	A T N P I I N O	20	i l		TION	VOLTAGE PROOF	CONTACT RESISTANCE CONTACT RESISTANCE NILLIVOLT LEVEL NETHOD.	TRICAL CH	NSTRUCTION ERAL EXAMINATION	ITEM		CURRE	PATING VOITAGE	APPLICABLE ST	COUNT DESCRIPTION OF
ELC4-018947	CTRIC CO. LID. SPECIFICATION	ification Test AT: Assu	specified, refer to 95, 2,20 8	8.2 NMin. (AWG-20)	£,	SOLDER TEMPERATURE, C FOR IMMERSION. DURATION. s.	IN PPN FOR ANDARD: JEIDA-39)	IN PPN FO FANDARD: JEIDA-3	EXPOSED IN & % SALT WATER SPRAY FOR	EXPOSED AT C h.	EXPOSED AT TO CYCLES (b).	TURE CYCLES.	ACIBALSTIC	URATI	Hz. Si	TIMES INSERTIENS AND EXTRA		ARACTERISTICS	DC AC FOR	700 mA (DC OR 1000 Hz). 20 mV MAX. mA (DC OR 1000 Hz).	CTERISTI	ISUALLY AND	TEST METHOD	SPECIFICA	T ACKOO	LA OLD TO BANNE B	ANDARD	REVISIONS BY CHAND DATE
CL 562-0493-7	HEET)	: Applicabl	2.20 95.2.22 95.	Lakameton. A	A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	FORMATION OF CAI SIVE LOOSENESS (NAL.			O CONTACT RESISTANCE: /Smr HAX.	O CONTACT RESISTANCE: DO MAX. O NO DAMAGE, CRACK AND LOOSENESS	O CONTACT RESISTANCE: MO MAX. O INSULATION RESISTANCE: NO MIN. (AT HIGH HUNIDITY) O INSULATION RESISTANCE: NO — UIN. (AT DRY) O AMAGE, CRACK AND LOOSENESS OF PARTS.	INSULATION RESISTANCE: NO DANAGE, CRACK AND LOOSENE OF PARTS.	SISTANC	OF PARTS.	O NO ELECTRICAL DISCONTINUITY OF CONTACT RESISTANCE: BO WAX.	ESISTANCE:	INSERTION FORCE N. MAX. EXTRACTION FORCE N. MIN.	FORCE 4,4 N. N.A.X.	NO FLASHOVER OR BREAKDOWN	75 mg MAX. O		ACCORDING TO DRAWING.	REQUIREMENTS QTA	TIONS MOKET	CABLE AWG	RANGE — CTO —		COUNT DESCRIPTION OF REVISIONS BY CHKO DATE